

TECHNICAL DATASHEET

STALOC MOULD RELEASE AGENT

PRODUCT DESCRIPTION

STALOC mould release agent is based on silicone- and wax-free special oils. It serves as a universal release agent for a reliable and easy demoulding of thermoplastic parts and thermosets. The product is solvent-free, thus ensures long life of the treated tools in production. Subsequent treatments of the demoulded parts, e.g. printing, varnishing, metallizing, gluing etc. are possible when the product is used properly.

APPLICATION

Recommended application – further information can be found in the material safety data sheet

Test before use. Clean mould before applying mould release agent. Apply thin layers from a distance of 30-40 cm. The thinner the layer, the better for the process of demoulding.

TECHNICAL PROPERTIES

ATTRIBUTE	UNIT	SPECIFICATION
smell		characteristic
density	g/cm³	0,59 at 20°C
shelf life	years	2 years
temperature resistance	°C	-20°C to +200°C
flashing point	°C	+300°C
boiling point	°C	+350°C
colour		transparent

SAFETY INFORMATION

Please send your request for the latest version of the material safety data sheet (MSDS).

PACKAGING / VOLUME

400 ml 520 3 e / 12 pcs. per box

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